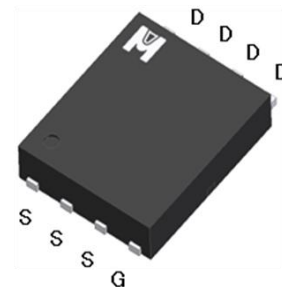
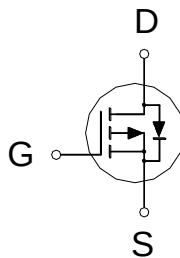


P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	-20V
$R_{DS(on)} (MAX.)$	5.5m Ω
I_D	-72A



UIS, R_g 100% Tested

RoHS & Halogen Free & TSCA Compliant



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	±12	V
Continuous Drain Current	T _C = 25 °C	I_D	-72	A
	T _C = 100 °C		-45	
Pulsed Drain Current ¹		I_{DM}	-240	
Avalanche Current		I_{AS}	-48	
Avalanche Energy	L = 0.1mH, I _{AS} = -48A, R _G = 25 Ω	E_{AS}	115	mJ
Repetitive Avalanche Energy ²	L = 0.05mH	E_{AR}	57	
Power Dissipation	T _C = 25 °C	P_D	50	W
	T _C = 100 °C		20	
Operating Junction & Storage Temperature Range		T _J , T _{stg}	-55 to 150	°C

100% UIS testing in condition of V_D = -15V, L = 0.1mH, V_G = -5V, I_L = -30A, Rated V_{DS} = -20V P-CH

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	R _{θJC}		2.5	°C / W
Junction-to-Ambient ³	R _{θJA}		62.5	

¹Pulse width limited by maximum junction temperature.

²Duty cycle < 1%

³The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz.

Copper, in a still air environment with T_A = 25°C.

⁴Guarantee by Engineering test

ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^{\circ}\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.4	-0.6	-1.2	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 12V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -16V, V_{GS} = 0V$			-1	μA
		$V_{DS} = -12V, V_{GS} = 0V, T_J = 125\text{ }^{\circ}C$			-10	
On-State Drain Current ¹	$I_{D(ON)}$	$V_{DS} = -5V, V_{GS} = -4.5V$	-72			A
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = -4.5V, I_D = -20A$		4.9	5.5	m Ω
		$V_{GS} = -2.5V, I_D = -20A$		5.9	6.6	
		$V_{GS} = -1.8V, I_D = -20A$		7.6	8.6	
Forward Transconductance ¹	g_{fs}	$V_{DS} = -5V, I_D = -20A$		52		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = -10V, f = 1MHz$		6945		pF
Output Capacitance	C_{oss}			605		
Reverse Transfer Capacitance	C_{rss}			515		
Gate Resistance	R_g	$V_{GS} = 15mV, V_{DS} = 0V, f = 1MHz$		3.3		Ω
Total Gate Charge ^{1,2}	Q_g	$V_{DS} = -10V, V_{GS} = -4.5V,$ $I_D = -20A$		49		nC
Gate-Source Charge ^{1,2}	Q_{gs}			10		
Gate-Drain Charge ^{1,2}	Q_{gd}			7.6		
Turn-On Delay Time ^{1,2}	$t_{d(on)}$	$V_{DS} = -10V,$ $I_D = -5A, V_{GS} = -4.5V, R_G = 3\Omega$		20		nS
Rise Time ^{1,2}	t_r			50		
Turn-Off Delay Time ^{1,2}	$t_{d(off)}$			250		
Fall Time ^{1,2}	t_f			120		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T _c = 25 °C)						
Continuous Current	I_S				-72	A
Pulsed Current ³	I_{SM}				-240	
Forward Voltage ¹	V_{SD}	$I_F = -20A, V_{GS} = 0V$			-1.2	V
Reverse Recovery Time	t_{rr}	$I_F = -20A, dI_F/dt = 100A / \mu S$		75		nS
Reverse Recovery Charge	Q_{rr}			480		nC



¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.



杰力科技股份有限公司
Excelliance MOS Corporation

EMF04P02H

Ordering & Marking Information:

Device Name: EMF04P02H for EDFN 5 x 6



→ F04P02: Device Name

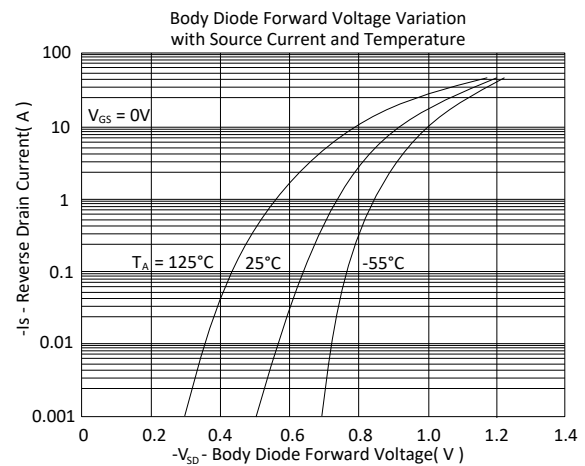
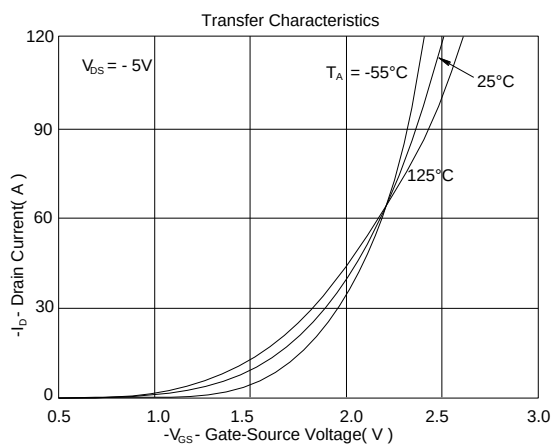
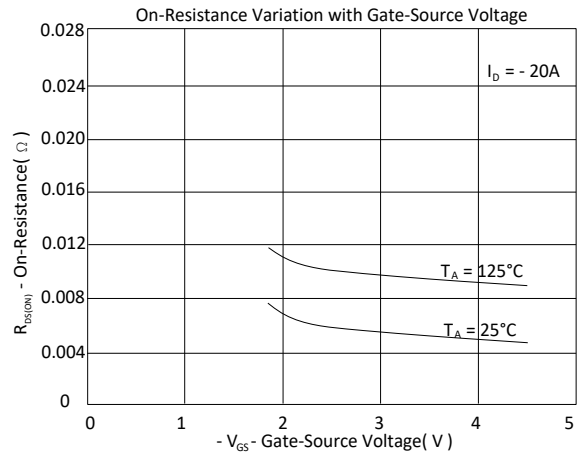
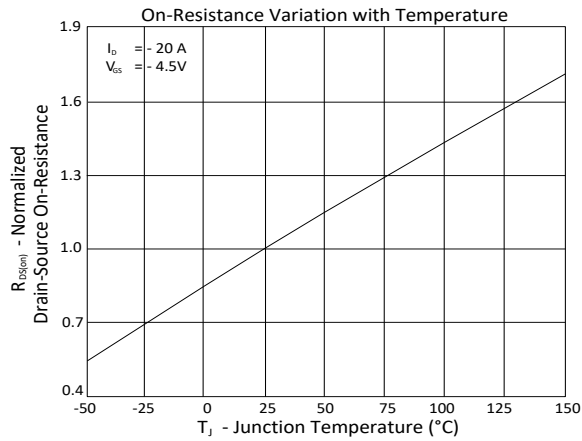
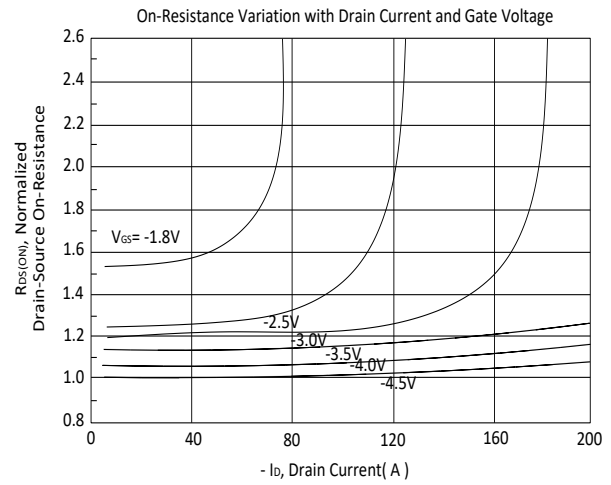
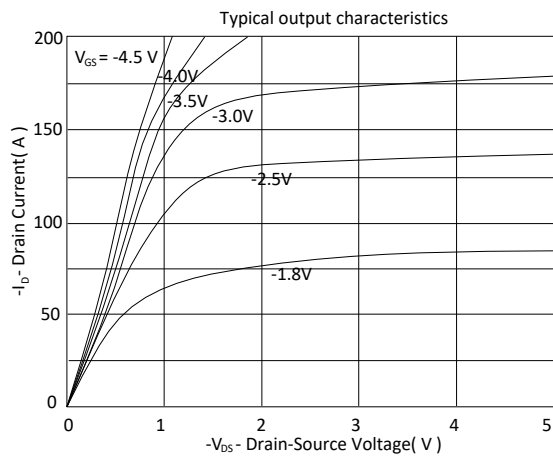
→ ABCDEFGH: Date Code

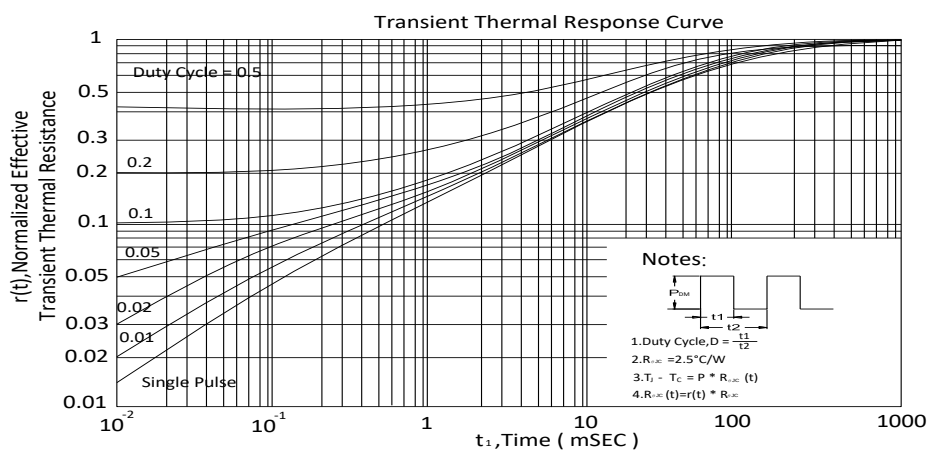
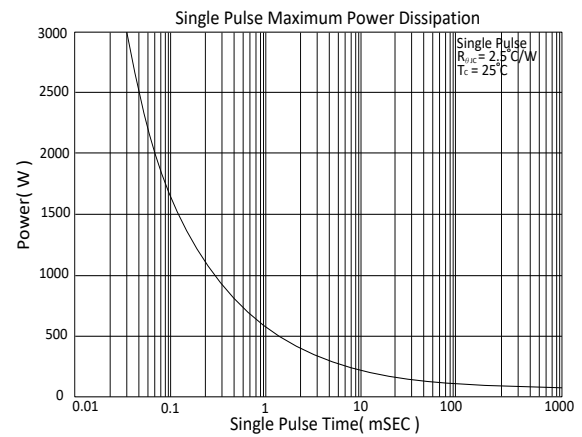
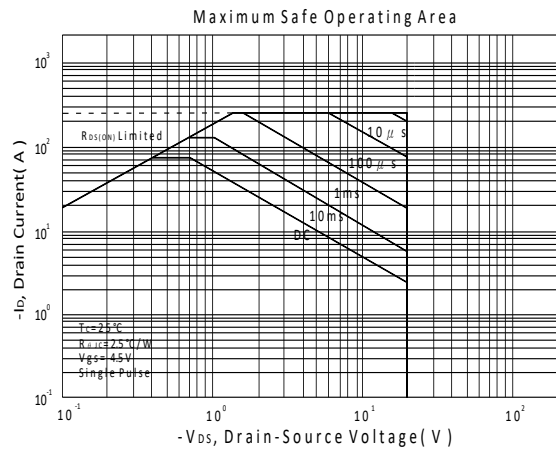
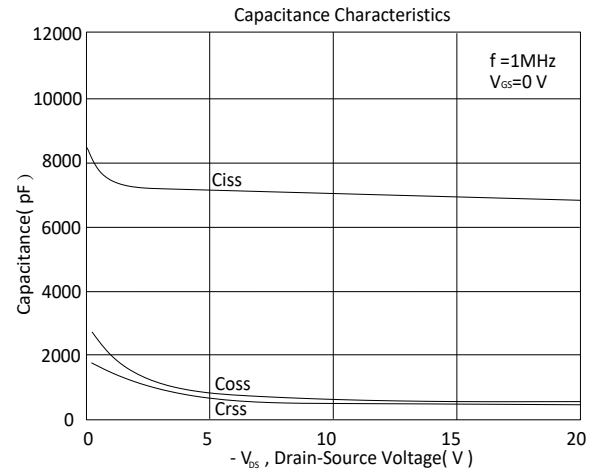
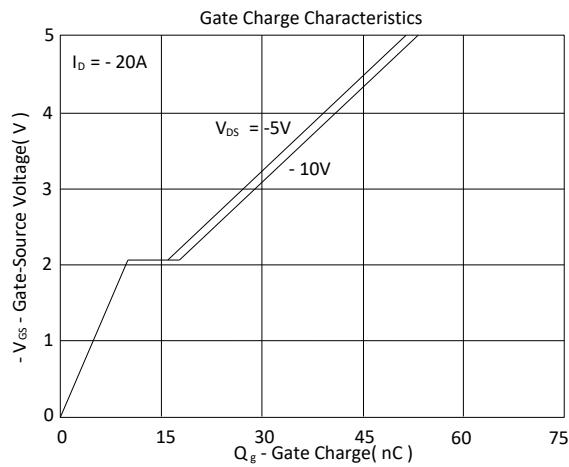
A: Assembly House

B: Year(A:2008 B:2009 C:2010....)

C: Month(A:01 B:02 C:03 D:04 E:05 F:06 G:07 H:08 I:09 J:10 K:11 L:12)

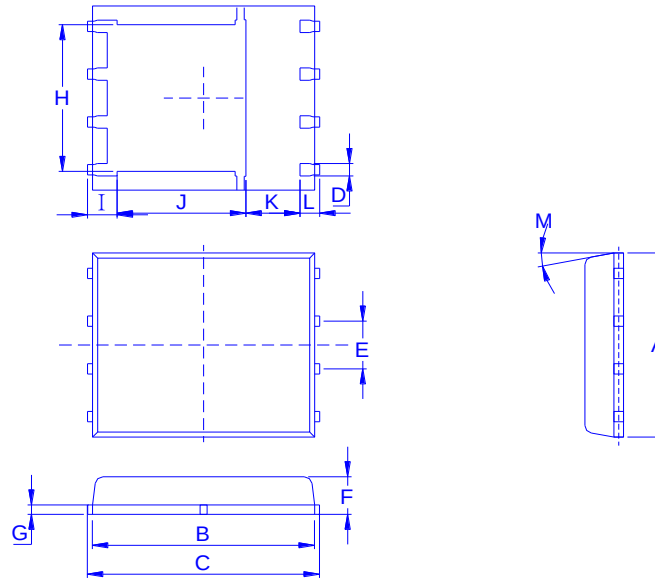
DEFG: Serial No.







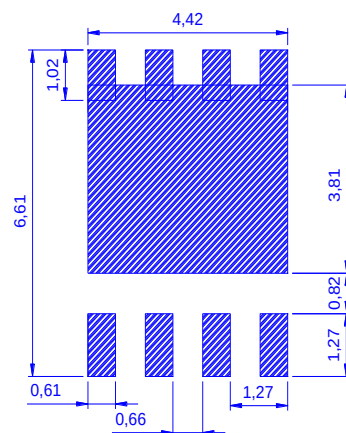
Outline Drawing



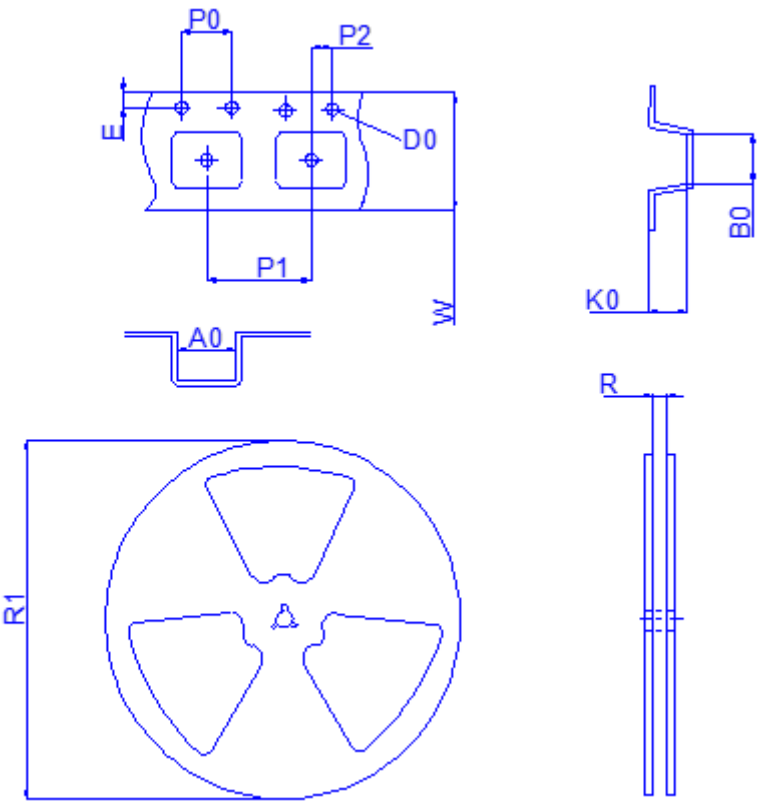
Dimension in mm

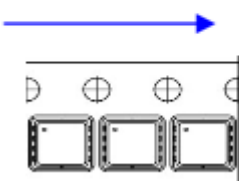
Dimension	A	B	C	D	E	F	G	H	J	K	L	M
Min	4.8	5.55	5.9	0.3	1.17	0.85	0.15	3.61	3.18	1	0.38	0°
Typ.	4.9	5.7	6	0.4	1.27	0.95	0.2	3.87	3.44	1.2	0.4	
Max	5.4	5.85	6.15	0.51	1.37	1.17	0.34	4.31	3.78	1.39	0.71	12°

Recommended minimum pads



Tape&Reel Information:2500pcs/Reel(Dimension in millimeter)



Package	EDFN5X6
Reel	13"
Device orientation	FEED DIRECTION 

Dimension in mm

Dimension	Carrier tape									Reel	
	A0	B0	D0	E	K0	P0	P1	P2	W	R	R1
Typ.	6.4	5.3	1.5	1.8	1.6	4	8	2	12	12.4	330
±	0.2	0.2	0.1	0.1	0.6	0.1	0.1	0.1	0.3	2	2